## VI. Bridge Rectifier

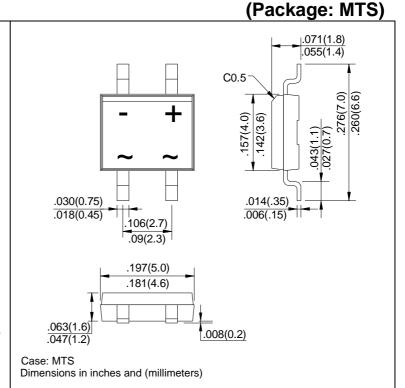
# 2.0A SMD Schottky Bridge Rectifiers (Low Profile Type) KMB22F~KMB210F

#### **FEATURES**

- Reliable low cost construction utilizing molded plastic technique.
- · Ultrafast reverse recovery time.
- High surge current capability.
- Saves space on printed circuit boards.
- High temperature soldering guaranteed: 260 / 10 seconds at terminals.

#### MECHANICAL DATA

- Case: Molded plastic body over schottky barrier chips.
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D.
- Polarity: Polarity symbols marked on case.
- Mounting position : Any.



### **Ratings & Electrical Characteristics**

Ratings at 25 ambient temperature unless otherwise specified

Characteristic	Symbol	KMB22F	KMB24F	KMB26F	KMB28F	KMB210F	Units
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	40	60	80	100	Volts
Maximum RMS voltage	V <sub>RMS</sub>	14	28	42	56	70	Volts
Maximum DC blocking voltage	V <sub>DC</sub>	20	40	60	80	100	Volts
Maximum average forward rectified current 0.2x0.2"(5.0x5.0mm) copper pad area	lo	2.0					Amps
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load.	I <sub>FSM</sub>	50					Amps
Maximum instantaneous forward voltage at 2.0A	$V_{F}$	0.50	0.55	0.70	0.	Volts	
Maximum DC reverse current at @Ta = 25 rated DC blocking voltage @Ta = 100	I <sub>R</sub>	0.5 20					mA
Typical junction capacitance (Note 1)	Cj	250			125		PF
Typical thermal resistance (Note 2)	Rth-JA Rth-JL	85 20					/W
Operating junction temperature range	Tj	-55 to +125					
Storage temperature range	Tstg	-55 to +150					

Notes:

<sup>1.</sup> Measured at 1 MHz and applied reverse voltage of 4.0 volts D.C.

<sup>2.</sup> Thermal resistance from junction to ambient and from junction to lead P.C.B. mounted on 0.2 x 0.2" (5.0 x 5.0mm) copper pad areas.

# Ratings and Characteristic Curves of KMB22F~KMB210F

